



MMST2222A

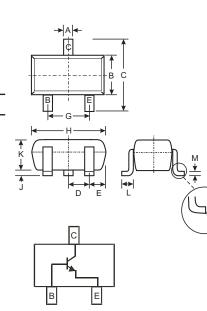
NPN SMALL SIGNAL SURFACE MOUNT TRANSISTOR

Features

- Epitaxial Planar Die Construction
- Complementary PNP Type Available (MMST2907A)
- Ultra-Small Surface Mount Package
- Lead Free/RoHS Compliant (Note 2)
- "Green" Device (Note 3 and 4)

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Terminal Connections: See Diagram
- Marking (See Page 2): K3P
- Ordering & Date Code Information: See Page 2
- Weight: 0.006 grams (approximate)



	SOT-323						
Dim	Min	Max					
Α	0.25	0.40					
В	1.15	1.35					
С	2.00	2.20					
D	0.65 N	ominal					
E	0.30	0.40					
G	1.20	1.40					
н	1.80	2.20					
J	0.0	0.10					
К	0.90	1.00					
L	0.25	0.40					
м	0.10	0.18					
α	0°	8°					
All Din	All Dimensions in mm						

Maximum Ratings @ $T_A = 25^{\circ}C$ unless otherwise specified

Characteristic	Symbol	MMST2222A	Unit
Collector-Base Voltage	V _{CBO}	75	V
Collector-Emitter Voltage	V _{CEO}	40	V
Emitter-Base Voltage	V _{EBO}	6.0	V
Collector Current - Continuous (Note 1)	Ι _C	600	mA
Power Dissipation (Note 1)	Pd	200	mW
Thermal Resistance, Junction to Ambient (Note 1)	R _{0JA}	625	°C/W
Operating and Storage and Temperature Range	Tj, T _{STG}	-55 to +150	°C

Note: 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout

document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

2. No purposefully added lead.

3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com./products/lead_free/index.php.

4. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



Electrical Characteristics $@T_A = 2$	25°C unless otherwise	specified			
间"MMST2222A Jure La	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 5)					•
Collector-Base Breakdown Voltage	V _{(BR)CBO}	75	_	V	$I_{C} = 10 \mu A, I_{E} = 0$
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	40	_	V	$I_{\rm C} = 10 {\rm mA}, \ I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	6.0	_	V	$I_{E} = 10 \mu A, I_{C} = 0$
Collector Cutoff Current	I _{CBO}	—	10	nA μA	$ \begin{array}{l} V_{CB} = 60V, \ I_E = 0 \\ V_{CB} = 60V, \ I_E = 0, \ T_A = 150^\circ C \end{array} $
Collector Cutoff Current	ICEX	—	10	nA	$V_{CE} = 60V, V_{EB(OFF)} = 3.0V$
Emitter Cutoff Current	I _{EBO}	_	10	nA	$V_{EB} = 3.0V, I_C = 0$
Base Cutoff Current	I _{BL}	_	20	nA	$V_{CE}=60V,\ V_{EB(OFF)}=3.0V$
ON CHARACTERISTICS (Note 5)					
DC Current Gain	h _{FE}	35 50 75 100 40 50 35	 300 	_	$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	_	0.3 1.0	V	$\begin{array}{l} I_C = 150 \text{mA}, \ I_B = 15 \text{mA} \\ I_C = 500 \text{mA}, \ I_B = 50 \text{mA} \end{array}$
Base-Emitter Saturation Voltage	V _{BE(SAT)}	0.6	1.2 2.0	V	$\begin{array}{l} I_C = 150 mA, \ I_B = 15 mA \\ I_C = 500 mA, \ I_B = 50 mA \end{array}$
SMALL SIGNAL CHARACTERISTICS					
Output Capacitance	C _{obo}	_	8	pF	$V_{CB} = 10V, f = 1.0MHz, I_E = 0$
Input Capacitance	C _{ibo}	_	25	pF	$V_{EB} = 0.5V, f = 1.0MHz, I_C = 0$
Current Gain-Bandwidth Product	fT	300	_	MHz	$V_{CE} = 20V, I_C = 20mA,$ f = 100MHz
Noise Figure	NF	_	4.0	dB	$\label{eq:Vce} \begin{array}{l} V_{CE} = 10V, \ I_C = 100 \mu A, \\ R_S = 1.0 k \Omega, \ f = 1.0 k Hz \end{array}$
SWITCHING CHARACTERISTICS					
Delay Time	t _d	_	10	ns	V _{CC} = 30V, I _C = 150mA,
Rise Time	tr	_	25	ns	$V_{BE(off)} = -0.5V, I_{B1} = 15mA$
Storage Time	ts		225	ns	V _{CC} = 30V, I _C = 150mA,
Fall Time	tf	_	60	ns	$I_{B1} = I_{B2} = 15 \text{mA}$

Ordering Information (Note 4 & 6)

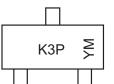
Device	Packaging	Shipping
MMST2222A-7-F	SOT-323	3000/Tape & Reel

Notes: 4. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

5. Short duration test pulse used to minimize self-heating effect.

6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

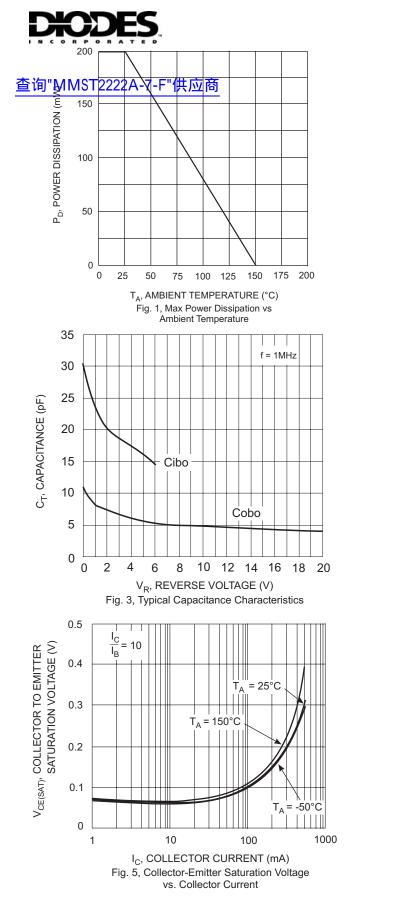
Marking Information

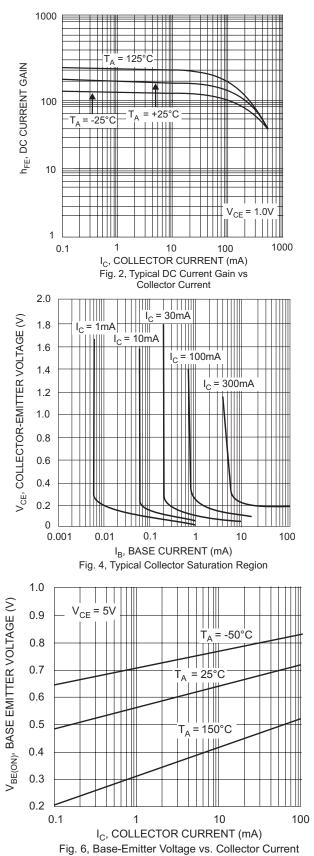


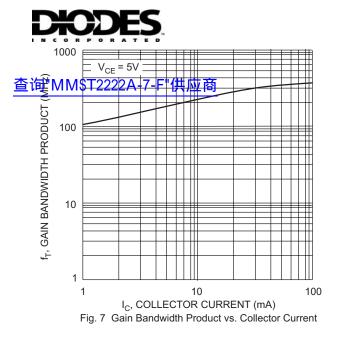
K3P = Product Type Marking CodeYM = Date Code MarkingY = Year ex: N = 2002M = Month ex: 9 = September

Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009
Code	J	К	L	М	Ν	Р	R	S	Т	U	V	W
		-										
Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec







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